

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2782	substrate and emboss\$4 and (releas\$3 slip\$4 anti-block\$3 anti-static) with agent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:56
L2	610	1 and (epoxy with resin) and (hardening filler)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 13:29
L3	17	2 and mylar	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 14:29
L4	1641	1 and (polymer epoxy resin) and (hardening filler)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:55
L5	133	4 and (carnauba with wax)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 13:30
L6	63	5 and (groove opening via hole) and wir\$3 and (chip die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 14:30
L7	55	6 and (computer processor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 13:33
L8	2560	(emboss\$4 with (layer film coat\$3)) and (releas\$3 slip\$4 anti-block\$3 anti-static) with agent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:43

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L9	123	8 and mylar	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 14:29
L10	22	9 and fill\$3 with (groove cavity gap opening via hole) with (metal conductive wir\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:43
L11	33	8 and ((releas\$3 slip\$4 anti-block\$3 anti-static) with agent) with ((montanic stearic myristic) with acid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 14:56
L12	8	11 and ((releas\$3 slip\$4 anti-block\$3 anti-static) with agent) with ((glycol polyethylene laurate) with ester)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:33
L13	4	11 and ((releas\$3 slip\$4 anti-block\$3 anti-static) with agent) with (microcrystalline with wax)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:33
L14	71	((emboss\$4 with (layer film coat\$3)) and (releas\$3 slip\$4 anti-block\$3 anti-static) with agent).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:43
L15	3	14 and ((groove cavity gap opening via hole) with (metal conductive wir\$3)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:49
L16	51	(koning-paul-a matayabas-james-c).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:50

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L17	53111	(emboss\$4 imprint\$3 mold\$3) with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:55
L18	1591	17 and (polymer resin expoxy) with ((releas\$3 slip\$4 anti-block\$3 anti-static) with agent)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 15:57
L19	33	18 and (emboss\$4 with tool)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 16:07
L20	10671	257/40,520,528,621,622,632,700, 701,759,784.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 16:18
L21	491	20 and 17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/12 16:19